

October 2000 Revised November 2000

# 74LVTH162373

# Low Voltage 16-Bit Transparent Latch with 3-STATE Outputs and $25\Omega$ Series Resistors in the Outputs

### **General Description**

The LVTH162373 contains sixteen non-inverting latches with 3-STATE outputs and is intended for bus oriented applications. The device is byte controlled. The flip-flops appear transparent to the data when the Latch Enable (LE) is HIGH. When LE is LOW, the data that meets the setup time is latched. Data appears on the bus when the Output Enable  $(\overline{OE})$  is LOW. When  $\overline{OE}$  is HIGH, the outputs are in a high impedance state.

The LVTH162373 is designed with equivalent  $25\Omega$  series resistance in both the HIGH and LOW states of the output. This design reduces line noise in applications such as memory address drivers, clock drivers, and bus transceivers/transmitters

The LVTH162373 data inputs include bushold, eliminating the need for external pull-up resistors to hold unused inputs.

These latches are designed for low-voltage (3.3V)  $V_{CC}$  applications, but with the capability to provide a TTL interface to a 5V environment. The LVTH162373 is fabricated with an advanced BiCMOS technology to achieve high speed operation similar to 5V ABT while maintaining a low power dissipation.

### **Features**

- $\blacksquare$  Input and output interface capability to systems at 5V  $V_{CC}$
- Bushold data inputs eliminate the need for external pull-up resistors to hold unused inputs
- Live insertion/extraction permitted
- Power Up/Down high impedance provides glitch-free bus loading
- $\blacksquare$  Outputs include equivalent series resistance of  $25\Omega$  to make external termination resistors unnecessary and reduce overshoot and undershoot
- Functionally compatible with the 74 series 16373
- Latch-up performance exceeds 500 mA
- ESD performance:

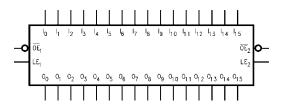
Human-body model > 2000V Machine model > 200V Charged-device model > 1000V

### **Ordering Code:**

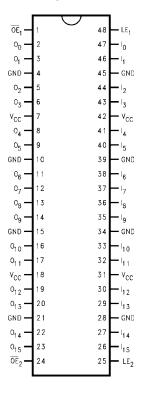
| Order Number                | Package<br>Number | Package Description   |
|-----------------------------|-------------------|---|
| 74LVTH162373MEA             | MS48A             | 48-Lead Small Shrink Outline Package (SSOP), JEDEC MO-118, 0.300 Wide [TUBES]               |
| 74LVTH162373MEX<br>(Note 1) | MS48A             | 48-Lead Small Shrink Outline Package (SSOP), JEDEC MO-118, 0.300 Wide [TAPE and REEL]       |
| 74LVTH162373MTD             | MTD48             | 48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide [TUBES]         |
| 74LVTH162373MTX<br>(Note 1) | MTD48             | 48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide [TAPE and REEL] |

Note 1: Use this Order Number to receive devices in Tape and Reel.

### **Logic Symbol**



# **Connection Diagram**



# **Pin Descriptions**

| Pin Names                       | Description                      |
|---------------------------------|----------------------------------|
| $\overline{OE}_n$               | Output Enable Input (Active LOW) |
| LE <sub>n</sub>                 | Latch Enable Input               |
| I <sub>0</sub> -I <sub>15</sub> | Inputs                           |
| O <sub>0</sub> -O <sub>15</sub> | 3-STATE Outputs                  |

### **Truth Tables**

|                 | Inputs          |                                | Outputs                        |
|-----------------|-----------------|--------------------------------|--------------------------------|
| LE <sub>1</sub> | OE <sub>1</sub> | I <sub>0</sub> –I <sub>7</sub> | O <sub>0</sub> -O <sub>7</sub> |
| Х               | Н               | Х                              | Z                              |
| Н               | L               | L                              | L                              |
| Н               | L               | Н                              | Н                              |
| L               | L               | Х                              | O <sub>o</sub>                 |

|   |                 | Inputs          |                                 | Outputs                         |
|---|-----------------|-----------------|---------------------------------|---------------------------------|
|   | LE <sub>2</sub> | OE <sub>2</sub> | I <sub>8</sub> -I <sub>15</sub> | O <sub>8</sub> -O <sub>15</sub> |
| Ī | Х               | Н               | Х                               | Z                               |
|   | Н               | L               | L                               | L                               |
|   | Н               | L               | Н                               | Н                               |
|   | L               | L               | Χ                               | O <sub>o</sub>                  |

H = HIGH Voltage Level

### **Functional Description**

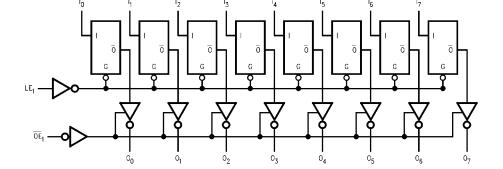
The LVTH162373 contains sixteen D-type latches with 3-STATE standard outputs. The device is byte controlled with each byte functioning identically, but independent of the other. Control pins can be shorted together to obtain full 16-bit operation. The following description applies to each byte. When the Latch Enable (LE<sub>n</sub>) input is HIGH, data on the D<sub>n</sub> enters the latches. In this condition the latches are transparent, i.e, a latch output will change states each time its D input changes. When LE<sub>n</sub> is LOW, the latches store information that was present on the D inputs a setup time preceding the HIGH-to-LOW transition of LE<sub>n</sub>. The 3-STATE standard outputs are controlled by the Output Enable  $(\overline{OE}_n)$  input. When  $\overline{OE}_n$  is LOW, the standard outputs are in the 2-state mode. When  $\overline{OE}_n$  is HIGH, the standard outputs are in the high impedance mode but this does not interfere with entering new data into the latches.

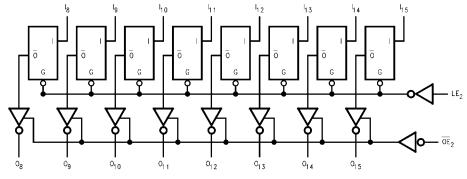
L = LOW Voltage Level

X = Immaterial Z = HIGH Impedance

 $O_0$  = Previous output prior to HIGH-to-LOW transition of LE

# Logic Diagrams





Please note that these diagrams are provided only for the understanding of logic operations and should not be used to estimate propagation delays.

# Absolute Maximum Ratings(Note 2)

| Symbol           | Parameter                        | Value        | Conditions  | Units |
|------------------|----------------------------------|--------------|---|-------|
| V <sub>CC</sub>  | Supply Voltage                   | -0.5 to +4.6 |   | V     |
| VI               | DC Input Voltage                 | -0.5 to +7.0 |   | V     |
| Vo               | DC Output Voltage                | -0.5 to +7.0 | Output in 3-STATE                                     | V     |
|                  |                                  | -0.5 to +7.0 | Output in HIGH or LOW State (Note 3)                  | V     |
| I <sub>IK</sub>  | DC Input Diode Current           | -50          | V <sub>I</sub> < GND                                  | mA    |
| I <sub>OK</sub>  | DC Output Diode Current          | -50          | V <sub>O</sub> < GND                                  | mA    |
| Io               | DC Output Current                | 64           | V <sub>O</sub> > V <sub>CC</sub> Output at HIGH State | mA    |
|                  |                                  | 128          | V <sub>O</sub> > V <sub>CC</sub> Output at LOW State  | IIIA  |
| I <sub>CC</sub>  | DC Supply Current per Supply Pin | ±64          |   | mA    |
| I <sub>GND</sub> | DC Ground Current per Ground Pin | ±128         |   | mA    |
| T <sub>STG</sub> | Storage Temperature              | -65 to +150  |   | °C    |

# **Recommended Operating Conditions**

| Symbol          | Parameter  | Min | Max | Units |
|-----------------|--|-----|-----|-------|
| V <sub>CC</sub> | Supply Voltage   | 2.7 | 3.6 | V     |
| VI              | Input Voltage  | 0   | 5.5 | V     |
| I <sub>OH</sub> | HIGH Level Output Current  |     | -12 | mA    |
| I <sub>OL</sub> | LOW Level Output Current   |     | 12  | mA    |
| T <sub>A</sub>  | Free-Air Operating Temperature                                       | -40 | 85  | °C    |
| Δt/ΔV           | Input Edge Rate, V <sub>IN</sub> = 0.8V–2.0V, V <sub>CC</sub> = 3.0V | 0   | 10  | ns/V  |

Note 2: Absolute Maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute maximum rated conditions is not implied.

Note 3: I<sub>O</sub> Absolute Maximum Rating must be observed.

## **DC Electrical Characteristics**

| Symbol             | Parameter                      |              | $V_{CC}$ $T_A = -40^{\circ}C$ |                       | C to +85°C | Units  | Conditions                            |  |
|--------------------|--------------------------------|--------------|-------------------------------|-----------------------|------------|--------|---------------------------------------|--|
| Symbol             | Farameter                      |              | (V)                           | Min                   | Max        | Ullits | Conditions                            |  |
| V <sub>IK</sub>    | Input Clamp Diode Voltage      |              | 2.7                           |                       | -1.2       | V      | I <sub>I</sub> = -18 mA               |  |
| V <sub>IH</sub>    | Input HIGH Voltage             |              | 2.7-3.6                       | 2.0                   |            | V      | $V_0 \le 0.1V$ or                     |  |
| V <sub>IL</sub>    | Input LOW Voltage              |              | 2.7-3.6                       |                       | 0.8        | V      | $V_O \ge V_{CC} - 0.1V$               |  |
| V <sub>OH</sub>    | Output HIGH Voltage            |              | 2.7-3.6                       | V <sub>CC</sub> - 0.2 |            | V      | $I_{OH} = -100 \mu\text{A}$           |  |
|                    |                                |              | 3.0                           | 2.0                   |            | V      | $I_{OH} = -12mA$                      |  |
| V <sub>OL</sub>    | Output LOW Voltage             |              | 2.7                           |                       | 0.2        | V      | $I_{OL} = 100 \mu A$                  |  |
|                    |                                |              | 3.0                           |                       | 0.8        | V      | $I_{OL} = 12 \text{ mA}$              |  |
| I(HOLD)            | Bushold Input Minimum Drive    |              | 3.0                           | 75                    |            | μА     | V <sub>I</sub> = 0.8V                 |  |
|                    |                                |              |                               | -75                   |            | μА     | $V_I = 2.0V$                          |  |
| I <sub>I(OD)</sub> | Bushold Input Over-Drive       |              | 3.0                           | 500                   |            | μА     | (Note 4)                              |  |
|                    | Current to Change State        |              |                               | -500                  |            | μΛ     | (Note 5)                              |  |
| l <sub>l</sub>     | Input Current                  |              | 3.6                           |                       | 10         |        | V <sub>I</sub> = 5.5V                 |  |
|                    | Γ                              | Control Pins | 3.6                           |                       | ±1         | μА     | $V_I = 0V$ or $V_{CC}$                |  |
|                    |                                | Data Pins    | 3.6                           |                       | -5         | μΑ     | $V_I = 0V$                            |  |
|                    |                                | Dala FIIIS   | 3.0                           |                       | 1          |        | $V_I = V_{CC}$                        |  |
| OFF                | Power Off Leakage Current      |              | 0                             |                       | ±100       | μΑ     | $0V \le V_I \text{ or } V_O \le 5.5V$ |  |
| I <sub>PU/PD</sub> | Power Up/Down 3-STATE          |              | 0-1.5V                        |                       | ±100       |        | $V_0 = 0.5V \text{ to } 3.0V$         |  |
|                    | Output Current                 |              | U-1.5V                        |                       | ±100       | μΑ     | $V_I = GND \text{ or } V_{CC}$        |  |
| OZL                | 3-STATE Output Leakage Current |              | 3.6                           |                       | -5         | μΑ     | V <sub>O</sub> = 0.5V                 |  |
| l <sub>ozh</sub>   | 3-STATE Output Leakage Current |              | 3.6                           |                       | 5          | μΑ     | $V_0 = 3.0V$                          |  |
| OZH <sup>+</sup>   | 3-STATE Output Leakage Current |              | 3.6                           |                       | 10         | μΑ     | $V_{CC} < V_O \le 5.5V$               |  |
| ССН                | Power Supply Current           |              | 3.6                           |                       | 0.19       | mA     | Outputs HIGH                          |  |
| I <sub>CCL</sub>   | Power Supply Current           |              | 3.6                           |                       | 5          | mA     | Outputs LOW                           |  |
| I <sub>CCZ</sub>   | Power Supply Current           |              | 3.6                           |                       | 0.19       | mA     | Outputs Disabled                      |  |

# DC Electrical Characteristics (Continued)

| Symbol             | Parameter                        | V <sub>CC</sub> | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ |      | Units | Conditions                             |  |
|--------------------|----------------------------------|-----------------|---|------|-------|--|--|
| Oymboi             | i arameter                       | (V)             | Min   | Max  | Onito | Conditions                             |  |
| I <sub>CCZ</sub> + | Power Supply Current             | 3.6             |   | 0.19 | mA    | $V_{CC} \le V_O \le 5.5V$ ,            |  |
|                    |                                  |                 |   |      |       | Outputs Disabled                       |  |
| $\Delta I_{CC}$    | Increase in Power Supply Current | 3.6             |   | 0.2  | mA    | One Input at V <sub>CC</sub> – 0.6V    |  |
|                    | (Note 6)                         | 3.0             |   | 0.2  |       | Other Inputs at V <sub>CC</sub> or GND |  |

Note 4: An external driver must source at least the specified current to switch from LOW-to-HIGH.

Note 5: An external driver must sink at least the specified current to switch from HIGH-to-LOW.

Note 6: This is the increase in supply current for each input that is at the specified voltage level rather than  $V_{CC}$  or GND.

# **Dynamic Switching Characteristics** (Note 7)

| Symbol           | Parameter                                    | v <sub>cc</sub> | $T_A = 25^{\circ}C$ |      | T <sub>A</sub> = 25°C |       | Conditions                             |
|------------------|--|-----------------|---------------------|------|-----------------------|-------|--|
| Symbol           | Falameter                                    | (V)             | Min                 | Тур  | Max                   | Units | $C_L = 50 \text{ pF}, R_L = 500\Omega$ |
| V <sub>OLP</sub> | Quiet Output Maximum Dynamic V <sub>OL</sub> | 3.3             |                     | 0.8  |                       | V     | (Note 8)                               |
| V <sub>OLV</sub> | Quiet Output Minimum Dynamic V <sub>OL</sub> | 3.3             |                     | -0.8 |                       | V     | (Note 8)                               |

Note 7: Characterized in SSOP package. Guaranteed parameter, but not tested.

Note 8: Max number of outputs defined as (n). n-1 data inputs are driven 0V to 3V. Output under test held LOW.

### **AC Electrical Characteristics**

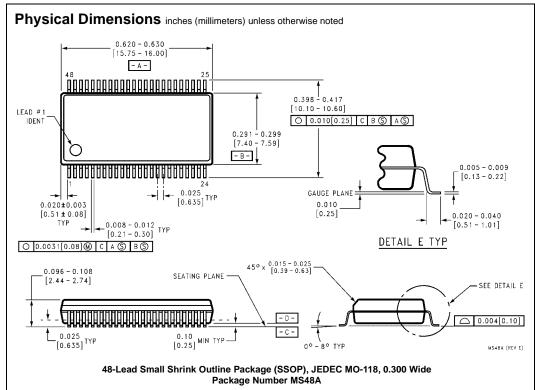
|                  |                                  | T <sub>A</sub> = -4 | 40°C to +85°C | , C <sub>L</sub> = 50pF, F | R <sub>L</sub> = <b>500</b> Ω |       |
|------------------|----------------------------------|---------------------|---------------|----------------------------|-------------------------------|-------|
| Symbol           | Parameter                        | V <sub>CC</sub> = 3 | 3.3V ± 0.3V   | $V_{CC} = 2.7V$            |                               | Units |
|                  |                                  | Min                 | Max           | Min                        | Max                           |       |
| t <sub>PHL</sub> | Propagation Delay                | 1.3                 | 4.8           | 1.3                        | 5.3                           | ns    |
| t <sub>PLH</sub> | D <sub>n</sub> to O <sub>n</sub> | 1.4                 | 4.8           | 1.4                        | 5.1                           | ns    |
| t <sub>PHL</sub> | Propagation Delay                | 1.7                 | 5.0           | 1.7                        | 5.1                           | ns    |
| t <sub>PLH</sub> | LE to O <sub>n</sub>             | 1.4                 | 5.1           | 1.4                        | 5.8                           | 115   |
| t <sub>PZL</sub> | Output Enable Time               | 1.6                 | 5.0           | 1.6                        | 6.0                           | ns    |
| $t_{PZH}$        |                                  | 1.0                 | 5.4           | 1.0                        | 6.6                           | 115   |
| t <sub>PLZ</sub> | Output Disable Time              | 1.6                 | 5.1           | 1.6                        | 5.0                           | ns    |
| $t_{PHZ}$        |                                  | 1.8                 | 5.4           | 1.8                        | 5.7                           | 115   |
| ts               | Setup Time, D <sub>n</sub> to LE | 1.0                 |               | 0.8                        |                               | ns    |
| t <sub>H</sub>   | Hold Time, D <sub>n</sub> to LE  | 1.0                 |               | 1.1                        |                               | ns    |
| t <sub>W</sub>   | LE Pulse Width                   | 3.0                 |               | 3.0                        |                               | ns    |
| toshl            | Output to Output Skew (Note 9)   |                     | 1.0           |                            | 1.0                           | ns    |
| toslh            |                                  |                     | 1.0           |                            | 1.0                           | 115   |

Note 9: Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (toSHL) or LOW-to-HIGH (toSLH).

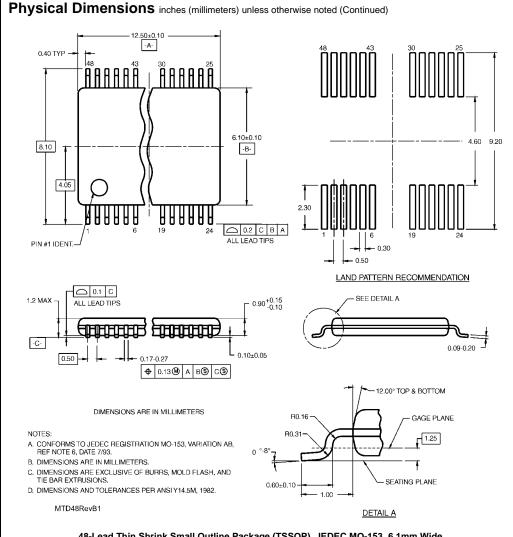
# Capacitance (Note 10)

| Symbol           | Parameter          | Conditions                                   | Typical | Units |
|------------------|--------------------|--|---------|-------|
| C <sub>IN</sub>  | Input Capacitance  | $V_{CC} = OPEN, V_I = 0V \text{ or } V_{CC}$ | 4       | pF    |
| C <sub>OUT</sub> | Output Capacitance | $V_{CC} = 3.0V$ , $V_{O} = 0V$ or $V_{CC}$   | 8       | pF    |

Note 10: Capacitance is measured at frequency f = 1 MHz, per MIL-STD-883, Method 3012.



Outputs



48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide Package Number MTD48

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